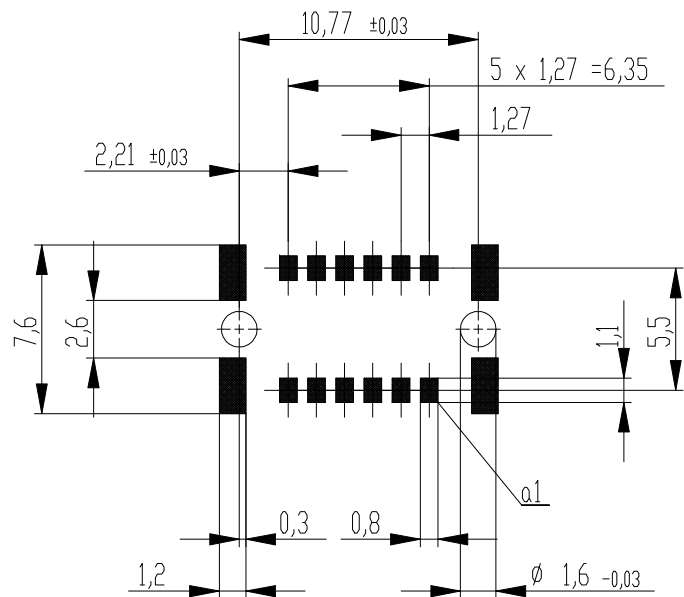
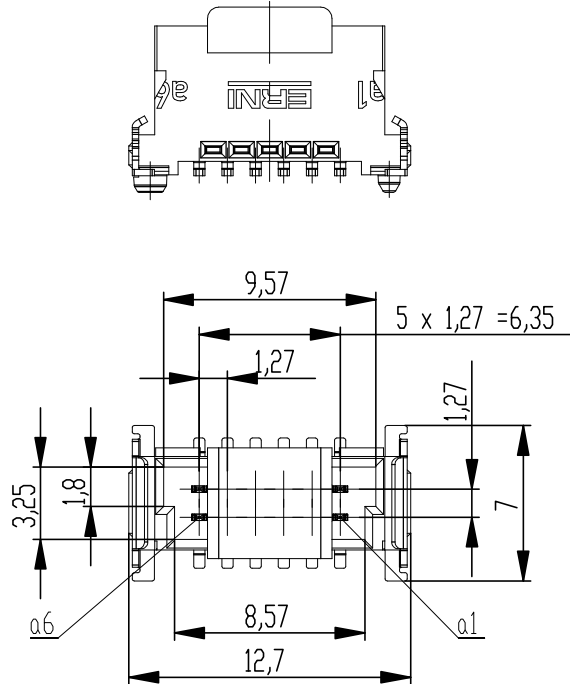
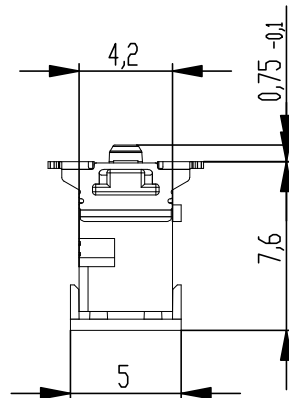
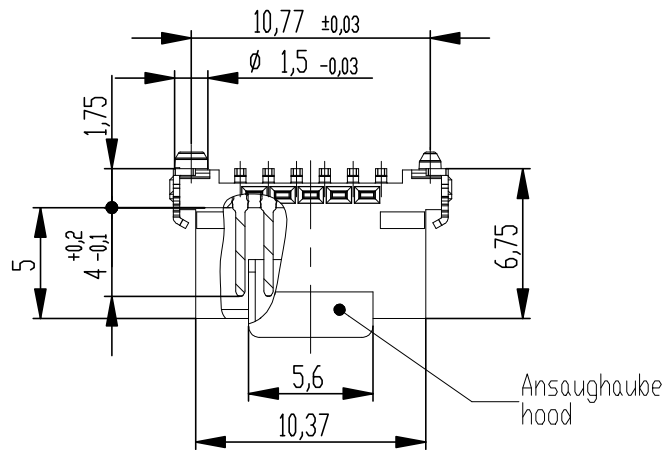


Die deutsche Version dieser Zeichnung dient nur zur Erleichterung der Handhabung. Bei Abweichungen von dem englischen Original gilt das englische Original.
The german version of this drawing has been offered for convenience only and may deviate from the english original.
In case of any deviation the English version shall prevail.

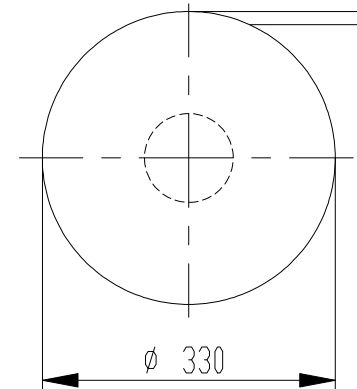
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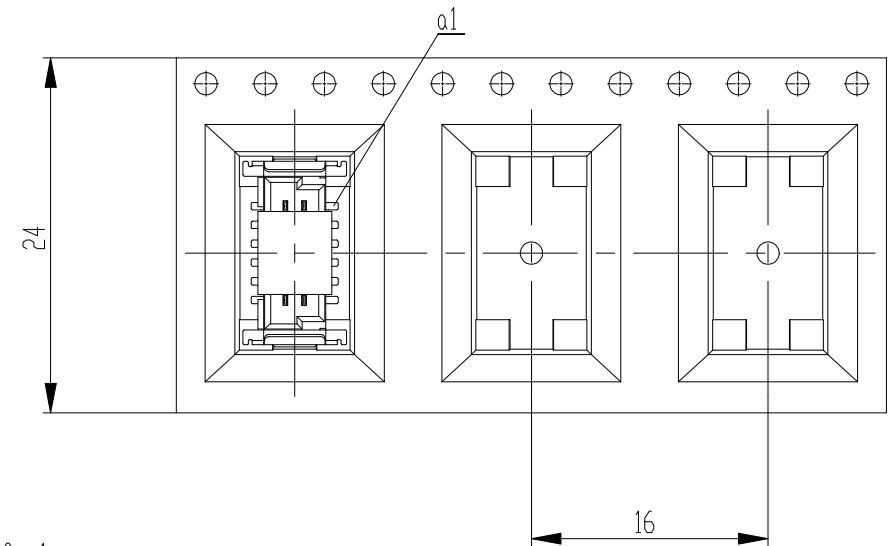
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
tape on reel packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
packaging unit: 280 pcs



Abspulrichtung - reel off direction



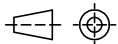
Anforderungsstufe 1
performance level 1

Kontaktbereich vergoldet
mating area gold plating

Anschlussbereich verzinkt 4-6 µm
terminal area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
coplanarity area of termination ≤ 0,1 mm

BA 8-13 - 8mm Bauhöhe
type 8-13 - Low Profile

Dimension no.				Tolerances Dim. for Information ISO 8015		 All Dimensions in mm		Scale 3:1			
<u>Customer drawing:</u> THIS DRAWING IS A CONTROLLED DOCUMENT.				Subject to modification without prior notice. Drawing will not be updated.				ERNI-Messerl. SMC-Q 12-SMD-BA8-13 Male SMC-Q 12-SMD-type8-13			
				f			12.08.2019		 TE Connectivity		C= 244836-E
Index			Date						SMCQ		